

4.2-W GU10 LED Lighting Driver Using Primary-Side Regulation

David Dou

China Power Reference Design

ABSTRACT

This application note introduces a low-wattage LED lighting driver solution using TI off-line primary-side sensing controller TPS92310. By using constant on-time flyback topology with primary sensing control, the solution can achieve high efficiency and good line and load regulation. The reference design PMP4325 is a suitable form factor for GU10 replacement LED lamp (30 mm x 18 mm x 10 mm), which can support universal AC line input and three or four LEDs in serial output with a constant output current of 350 mA. The experiment demonstrates that this solution has good line and load regulation, high efficiency, and overall protection for LED lighting.

Contents

1	Theory Operation					
	1.1	The TPS92310 Controller	3			
	1.2	Constant On-time Control	3			
	1.3	Constant current control with Primary Side Sensing	4			
	1.4	ZCD Detection, Delay Set and Output Overvoltage	6			
	1.5	Output Short-circuit Protection	8			
	1.6	External Line Regulation Compensation	9			
2	Trai	nsformer Design	12			
3	Exp	erimental Results	14			
	3.1	Electrical Performance Specifications	14			
	3.2	Reference Design Schematic	14			
	3.3	PMP4325 PCB Layout	15			
		3.3.1 PCB Layout Without SCP and Line Regulation Compensation Circuit	15			
	3.4	Electrical Performance	15			
		3.4.1 Efficiency Curve at 3- and 4-LED Applications	16			
		3.4.2 Line Regulation Curve	16			
		3.4.3 Line Regulation Curve With Compensation Circuit	17			
		3.4.4 Start-up Output Waveform	17			
		3.4.5 Output Ripple Voltage and Current	18			
		3.4.6 Output Overvoltage and Open LED Protection	18			
		3.4.7 Two-LED Protection	19			
		3.4.8 Output Short-circuit Protection	19			
	3.5	Conducted EMI	20			
		3.5.1 EMI for 4-LED GU10 Load With Y CAP	20			
		3.5.2 EMI for 3-LED GU10 Load With Y CAP	20			
		3.5.3 EMI for 3-LED GU10 Load Without Y CAP	21			
	3.6	Bill of Materials	22			
	3.7 I ransformer specification					
Ref	ereno	Ces	24			



Figures

Figure 1.	Current Waveform During T _{ON} and T _{OFF}	4
Figure 2.	Current and V _{ds} Voltage Waveform	5
Figure 3.	Charge and Discharge Block Diagram	5
Figure 4.	TPS92310 Block Diagram	6
Figure 5.	Typical Switching Waveform	7
Figure 6.	T _{dly} Set Curve	7
Figure 7.	ZCD Pin Connect Circuit	8
Figure 8.	Output Short-circuit Protect (SCP) Waveform	9
Figure 9.	Inherent Propagation Delay	10
Figure 10.	Rapid Shut-down Circuit	10
Figure 11.	External Line Regulation Compensation Circuit	10
Figure 12.	Line Regulation Compensation Curve	11
Figure 13.	PMP4325 Reference Design Schematic	14
Figure 14.	Component Side and Solder Side of Demo Board	15
Figure 15.	PCB Layout of Released Demo Board	15
Figure 16.	Efficiency Curve With 3- and 4-LED Loads	16
Figure 17.	Line Regulation of LED Current	16
Figure 18.	Line Regulation of LED Current With Compensation	17
Figure 19.	Start-up Test With 110 VAC	17
Figure 20.	Start-up Test With 230 VAC	17
Figure 21.	Output Ripple Test With 110 VAC	18
Figure 22.	Output Ripple Test With 230 VAC	18
Figure 23.	OVP Test With 110 VAC	18
Figure 24.	OVP Test With 230 VAC	18
Figure 25.	Shorting Two LEDs Test With 110 VAC	19
Figure 26.	Shorting Two LEDs Test With 230 VAC	19
Figure 27.	Output Short-circuit Test With 110 VAC	19
Figure 28.	Output Short-circuit Test With 230 VAC	19
Figure 29.	Conducted EMI With 230 VAC, Line	20
Figure 30.	Conducted EMI With 230 VAC, Neutral	20
Figure 31.	Conducted EMI With 230 VAC, Line	20
Figure 32.	Conducted EMI With 230 VAC, Neutral	20
Figure 33.	Conducted EMI With 230 VAC, Line	21
Figure 34.	Conducted EMI With 230 VAC, Neutral	21
Figure 35.	10-Pin Horizontal Bobbin	23
Figure 36.	Transformer Electrical Diagram	24
Figure 37.	Transformer Building Construction Diagram	24

Tables

Table 1.	PMP4325 Electrical Performance Specifications	.14
Table 2.	PMP4325 Bill of Materials	.22
Table 3.	Transformer Electrical Specification	.24



1 Theory Operation

1.1 The TPS92310 Controller

Single-stage flyback is a highly-attractive topology for LED lighting with low power rating. Single-stage flyback is widely used for LED lighting for the following reasons:

- Low total BOM with electrical isolation
- High power factor using specific control architectures, such as constant on-time control
- Small form factor compared to other two-stage topology

Although single-stage flyback has benefits for LED lighting, some issues still require resolution. These issues are:

- High power factor
- Primary-Side Regulation (PSR) with good line and load regulation
- Open or short protections of LEDs

The TI TPS92310 controller is a single-stage primary-side sensing AC/DC controller to drive a constant current for high-brightness LEDs. It runs at transition mode (TM) with zero-current-detection. The ON-Time (T_{ON}) is nearly constant within a half-cycle of the line voltage. Hence, it has inherent power factor correction (PFC) because the peak current of the primary winding is following with the input line voltage profile. The T_{ON} is adjusted so that the LED current is regulated at a preset level which is set by an external-sense resistor. The T_{ON} is also used to design for controlling a flyback, boost and buck-boost converter operating in TM with fixed on-time control to achieve high PF, and also for controlling a buck converter in TM with peak current control for general LED driver.

Primary-side sensing does not require opto-coupler and secondary-side circuitry and hence a low component count and compact PCB solution. Additionally, the controller provides features such as cycle-by-cycle current limit, output short-circuit protection, output overvoltage protection (OVP), or open LED protection, short-LED protection, and thermal shutdown; all of which provide protections for LED lighting.

1.2 Constant On-time Control

In a conventional boost PFC converter, TM with constant on-time control is generally used to keep input current in-phase with input voltage for high PF and low THD.

For single-stage flyback topology with TM, it is not the natural PFC because the duty cycle and frequency will always change during the switching cycle. So the power factor and THD is not optimal at this condition. Fortunately, the fixed or constant T_{ON} with TM single-stage flyback can still achieve a high PF and low THD; as shown in Figure 1, the average input current is an approximate sinusoidal wave with the same phase of input voltage.





Figure 1. Current Waveform During Ton and TOFF

The TPS92310 controller is configured on constant on-time control mode in this design, the turnon time of the switch can be fixed if a large capacitor is connected to the COMP pin to filter 100-Hz line ripple in a single stage flyback application. However, to reduce the size of the board, this reference design is not a single stage without PFC function, so a small compensation capacitor is used only to keep the stabilization of control loop, the turn-on time is almost fixed because of stable DC input voltage for flyback.

1.3 Constant current control with Primary Side Sensing

The primary current, secondary current and V_{ds} voltage are shown in Figure 2, according to this, the average output current I_o can be calculated as following equation (1).

$$I_{o} = \frac{I_{s_{-}pk} \times T_{OFF}}{2 \times (T_{ON} + T_{OFF} + 2 \times T_{dly})} = \frac{I_{p_{-}pk} \times N \times T_{OFF}}{2 \times (T_{ON} + T_{OFF} + 2 \times T_{dly})}$$
(1)

Where:

 $2 \times T_{dly}$ = half time of ringing period on MOSFET drain

N = transformer turn ratio of primary winding to secondary winding

I_{p_pk} = primary current

 I_{s_pk} = secondary current

I_o = average output current (LED current)





Figure 2. Current and V_{ds} Voltage Waveform

To regulate the output current, the converter used a PWM control circuit, as shown in Figure 3. This circuit includes charge and discharge operation modes. The charge operation mode is controlled by an internal reference current $I_{REF} \times time (T_{ON} + T_{OFF} + 2T_{DLY})$. The discharge operation mode is controlled by a T_{OFF} switch and I_{pk} current source, which is proportional to the primary side peak current. COMP voltage level can represent a gate drive T_{ON} .

During normal operation, if discharge $Q(I_{pk} \times T_{OFF})$ is greater than charge $Q(I_{REF} \times (T_{ON} + T_{OFF} + 2T_{DLY}))$, the COMP pin voltage decreases, as a result gate output T_{ON} decreases at the next cycle._Otherwise, if the charge $Q(I_{REF} \times (T_{ON} + T_{OFF} + 2T_{DLY}))$ is larger than discharge $Q(I_{pk} \times T_{OFF})$, V_{COMP} increases, gate driver output T_{ON} increases at the next cycle. If the charge Q equals the discharge Q, the V_{COMP} voltage will be stable. So when a capacitor of large capacitance is connected to the COMP pin for filtering 100-HZ line ripple, a fixed on-time is generated during the half sinusoidal cycle, so a PF correction is implemented. A small capacitor will be connected to the COMP pin when it only works on flyback topology without PFC to maintain loop stability.



Figure 3. Charge and Discharge Block Diagram

The controller implements primary current feedback and regulation to maintain constant output LED current. Figure 4 shows a block diagram of the TPS92310 controller; the red virtual line presents a main control loop.





Figure 4. TPS92310 Block Diagram

1.4 ZCD Detection, Delay Set and Output Overvoltage

The zero cross detect (ZCD) pin detects transformer auxiliary winding for zero current. When the ZCD voltage is lower than V_{ZCD} (TRIG) level, the internal RS flip-flop passes a ZCD signal to IDLY delay block to trigger the next switching cycle. The dual-level detect on this pin (ARM/TRIG) ensures the switching FET turns ON at zero current of the secondary side of the isolation transformer. Figure 5 shows a typical switching waveform on the DRAIN of the switching FET. The controller also offers a blank time of 300 ns for ZCD detection to avoid any possible ringing impact.

To reduce EMI and switching loss during converter operation, a DLY pin of the TPS92310 controller is provided. Connecting an external resistor can control the delay timer easily. Through the IDLY pin, the converter ensures the transformer winding has zero current instead of the main switching FET turning ON. The preset delay timer value must be considered against the resonance frequency between the primary inductance of the isolation transformer and the switching FET drain charge. The T_{dly} can be calculated by the following equation.

$$T_{dly} = \frac{1}{2} \times \pi \times \sqrt{L_p \times C_{OSS}}$$

(2)

Where:

L_p = transformer primary inductance

Coss = MOSFET output capacitance

 T_{dy} is used to control discharge time of V_{COMP} , so it must be set by external resistor connected on DLY pin, as shown in Figure 6.





Figure 5. Typical Switching Waveform



Figure 6. T_{dly} Set Curve

The ZCD pin is also used as output overvoltage protection. The positive voltage on auxiliary winding presents an output LED voltage and can be detected by external divided resistor, as shown in Figure 7. The overvoltage on the ZCD pin exceeds the OVP threshold by three cycles. The drive output should be shut down, and the controller implements a restart mode. The OVP voltage can be calculated by the following equation.

$$V_{O_{-}OVP} = \frac{N_s}{N_a} \times \frac{V_{OVP}}{R_L} \times (R_U + R_L) - V_D$$
(3)

Where:

Ns = turns of auxiliary winding

N_a = turns of output winding

 V_D = forward voltage of output rectifier

The negative voltage on auxiliary winding represents a reflected voltage of input voltage, therefore power dissipation on the resistor is considered when selecting R_U . A current flow of 0.2 to 0.5 mA is suitable. A diode is connected to the ZCD pin to clamp the negative voltage below 1 V. A small capacitor, C, is always connected between the ZCD pin and GND to eliminate possible ringing impact, ensure accurate OVP, and obtain a suitable valley switching on.





Figure 7. ZCD Pin Connect Circuit

1.5 Output Short-circuit Protection

The TPS92310 controller operates at voltage mode control, and a cycle-by-cycle limit is needed for OCP and SCP. The controller provides two constant on-time modes with different OCP thresholds (0.64 V and 3.4 V) in this isolated flyback. A sensing voltage of primary current can be calculated with the following equation:

$$V_{isns} = \frac{2 \times REF}{\eta} \times \frac{V_{LED}}{V_{LED} + V_D} \times \frac{V_{in_\min} + V_{or}}{V_{in_\min}}$$
(4)

Where:

REF = 0.14 by controller

 $V_{\text{LED}} = 12 \text{ V}$

 $V_{\rm D} = 0.8 \ V$

 $V_{in_{min}} = 127 \text{ Vdc}$

 V_{or} = about 85 V in this design, equals Nx(V_{LED} + V_D)

 η = efficiency is evaluated about 0.8 at low line

For this conventional flyback design, V_{isns} is about 0.53 V.



Because of fixed V_{in_min} voltage and almost fixed V_{or} designing voltage, the V_{isns} is almost constant when there is a different LED voltage. This detecting voltage is lower than the OCP threshold, so constant on-time mode with 0.64 V OCP threshold can be configured for perfect output short-circuit protection. This mode can be used in all conventional flyback designs. To avoid the ringing interference for ZCD detection during output short-circuits, a small capacitor must be connected between the ZCD pin and GND to avoid false ZCD detection; a 10-pF capacitor is suitable in this design. Figure 8 show the output short-circuit waveform.



Figure 8. Output Short-circuit Protect (SCP) Waveform

1.6 External Line Regulation Compensation

There is a different peak current at high line and low line because of controller inherent propagation delay, as shown in Figure 9. The high-line input voltage results in a much higher current difference than does the low line input voltage with the same propagation delay. According to Equation 1, the error on the input current sensing impacts LED current, and line regulation is not very well. There are two ways to improve line regulation when input voltage is changed from low line to high line:

- 1. Add a fast shut-down circuit (shown in Figure 10). It can reduce the MOSFETs turning on delay and improve the current tolerance of 5 mA at 230 Vac in this design.
- Add an input voltage detection circuit (shown in Figure 11) to reduce on-time at high line; it can reach the desired high current precision by adjusting R17 at 110 Vac and 230 Vac line. R19, R19, and R20 decide the inflection point of LED current. Figure 12 shows a line regulation ratio curve with external compensation.



Figure 9. Inherent Propagation Delay







Figure 11. External Line Regulation Compensation Circuit





Figure 12. Line Regulation Compensation Curve



2 Transformer Design

According to the previous description, to use an external SCP circuit, the V_{isns} must be set below 0.6 V.

$$V_{isns} = R_{CS} \times I_P \tag{5}$$

$$R_{CS} = \frac{N \times 0.14}{I_{LFD}} \tag{6}$$

So
$$I_P = \frac{V_{isns} \times I_{LED}}{0.14 \times N}$$
 (7)

$$D_{MAX} = \frac{V_{or}}{V_{in} \min + V_{or}} = \frac{N \times (V_{LED} + V_D)}{V_{in} \min + N \times (V_{LED} + V_D)}$$
(8)

$$I_P = \frac{2 \times I_{av}}{D_{MAX}} = \frac{2 \times P_O}{\eta \times V_{in_\min} \times D_{MAX}} = \frac{2 \times V_{LED} \times I_{LED}}{\eta \times V_{in_\min} \times D_{MAX}}$$
(9)

Combining equations 7, 8, and 9, yields

$$N = \frac{\eta \times V_{isns} \times V_{in} \min}{0.28 \times V_{LED}} - \frac{V_{in} \min}{V_{LED} + V_D}$$
(10)

Where:

 V_{isns} = sensing voltage of primary current (set below 0.6 V if using external SCP circuit, otherwise no limit)

 R_{cs} = current sense resistor

N = transformer turn ratio of primary winding to output winding

 I_P = primary peak current

V_{or} = primary reflection voltage of secondary voltage

 $I_{LED} = LED$ current

V_{LED} = LED voltage

 η = evaluated power supply efficiency

V_D = forward voltage of output rectifier

Vin_min = minimum input DC voltage, usually simple to 1.3 Vac_min

The transformer specification can be calculated as the following equations:

$$L_P = \frac{V_{in} \min \times D_{MAX}}{I_P \times F_S MIN}$$
(11)



$$N_P = \frac{L_P \times I_P}{\Delta B_{MAX} \times A_e} \tag{12}$$

$$N_{out} = \frac{N_P}{N} \tag{13}$$

$$N_{aux} = \frac{N \times (V_{aux} + V_D_{aux})}{V_{LED} + V_D}$$
(14)

Where:

L_p = primary inductance

N_p = the turns of primary winding

N_{out} = the turns of output winding

 N_{aux} = the turns of auxiliary winding, usually less than calculated value because of influence of spike voltage

 D_{MAX} = maximum duty cycle, calculated by equation 2

 $F_{S_{MIN}}$ = setting minimum switching frequency at low line

 $\triangle B_{MAX}$ = selecting maximum working flux density

 A_e = effective core area

V_{aux} = selecting Vcc voltage

V_{D out} = forward voltage of auxiliary rectifier

Finally, RMS current and peak voltage on primary MOSFET can be selected and secondary rectifier for MOSFET and rectifier and build transformer can be selected according RMS current and bobbin windows.

3 Experimental Results

3.1 Electrical Performance Specifications

Table 1. PMP4325 Electrical Performance Specifications

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
Input Characteristics						
Voltage range		85		265	Vrms	
Output Characteristics						
Output voltage, Vout	Output current = 350 mA	8	12	13	V	
Output load current, Iout			350		mA	
Output current ripple	V_{out} = 12 V, I_{out} = 350 mA, V_{in} = 230 Vac		105		mApp	
Systems Characteristics						
Efficiency	Universal input, V _{out} = 12 V		78		%	

3.2 Reference Design Schematic



Figure 13. PMP4325 Reference Design Schematic



3.3 PMP4325 PCB Layout

This reference design is implemented on a double-sided PCB that is dimensionally compatible with the GU10 LED lamp and similar applications. To meet different requirements, two versions of PCB layout file are provided:

- 1. Released demo board without output SCP line regulation compensation circuit.
- 2. PCB file provided to some customers who requires a good SCP and line regulation functions.



Figure 14. Component Side and Solder Side of Demo Board

3.3.1 PCB Layout Without SCP and Line Regulation Compensation Circuit



Figure 15. PCB Layout of Released Demo Board

3.4 Electrical Performance

Figure 16 through Figure 18 gives typical performance curves for the PMP4325 9-V and 12-V, 350-mA LED driver.



3.4.1 Efficiency Curve at 3- and 4-LED Applications







Figure 17. Line Regulation of LED Current



3.4.3 Line Regulation Curve With Compensation Circuit





3.4.4 Start-up Output Waveform





Figure 20. Start-up Test With 230 VAC

3.4.5 Output Ripple Voltage and Current



Figure 21. Output Ripple Test With 110 VAC

Figure 22. Output Ripple Test With 230 VAC



3.4.6 Output Overvoltage and Open LED Protection



3.4.7 Two-LED Protection







3.4.8 Output Short-circuit Protection







3.5 Conducted EMI

3.5.1 EMI for 4-LED GU10 Load With Y CAP



Figure 29. Conducted EMI With 230 VAC, Line

3.5.2 EMI for 3-LED GU10 Load With Y CAP





Figure 30. Conducted EMI With 230 VAC, Neutral

0.50

1.00

5.00 10.00

30.000 MHz

0.01

0.009 MHz

0.05 0.10



Figure 32. Conducted EMI With 230 VAC, Neutral



3.5.3 EMI for 3-LED GU10 Load Without Y CAP



Figure 33. Conducted EMI With 230 VAC, Line



Figure 34. Conducted EMI With 230 VAC, Neutral

3.6 Bill of Materials

QTY	RefDes	Description	MFR	Part Number
1	D2	Switching Diode, 0.2A,/200V, SOT23	ON Semi	BAS20LT1G
1	C4	Capacitor, chip,4.7 uf, 35 V,1206	TDK	C3216X7R1V475K
1	C5	Capacitor, chip,10 pF/10 V, 10%, 0603	Std	Std
1	C7	Capacitor, chip, 4700 pF/10 V, 10%, 0603	Std	Std
1	C10	Capacitor, chip, 10uF/25 V, 10%, 1206	TDK	C3216X7R1E106M
1	C3	Capacitor, chip,3300 pF/ 630 V, 10%, 1206	TDK	C3216X7R2J332K
1	D1	Bridge Rectifier, 600 V, 0.5 A, SMD	FSC/others	MB6S
1	D5	Schotty Diode, 2 A, 100 V, SMA	ON/Diodes	MBRA2H100G
1	D3	Standard Rectifier, 1 A, 1000 V, SMA	ON/Diodes	4007/SMA
1	L1	Inductor, 1mH,0.2A, 6mm 8.5 mm	LEDpower	Custom
1	C11	Y1 CAP,680pF, Optional	Std	Std
1	T1	EPC13, 10pin Horizontal bobbin	LEDpower	Custom
1	FR	Fusible Resistor, 10R, 1W	Vitrohm	CRF251-4
1	R2	Resistor, chip, 0 ohm, 0603	Std	Std
1	R2	Resistor, chip, 1/8W, 5%, 0603	Std	Std
1	R8	Resistor, chip, 1/4W, 1%, 1206	Std	Std
1	R9	Resistor, chip, 1/8W, 1%, 0603	Std	Std
1	R10	Resistor, chip, 1/8W, 1%, 0603	Std	Std
2	R5	Resistor, chip, 1/5W, 5%, 0805	Std	Std
1	R13	Resistor, chip, 1/8W, 5%, 0603	Std	Std
1	R14	Resistor, chip, 1/5W, 1%, 0805	Std	Std
1	R15	Resistor, chip, 1/5W, 1%, 0805	Std	Std
1	R1	Resistor, chip, 1/5W, 5%, 0805	Std	Std
1	R3	Resistor, chip, 1/4W, 5%, 1206	Std	Std
2	R6 R7	Resistor, chip, 1/4W, 5%, 1206	Std	Std
1	R16	Resistor, chip, 1/5W, 5%, 0805	Std	Std
1	R4	Resistor, chip, 1/4W, 5%, 1206	Std	Std
1	C2	ECAP, 4.7 uF/400 V, 8 mm x 11.5 mm, 105° C, 5000h	Capxon	KW series
1	C1	Capacitor, chip, 0.1 uF/450 V, 1206	TDK	C3216X7T2W104M
1	D4,D7	Switching diode, 0.2 A, 100 V, SOD323	ON SemI	MMDL914T1G
1	D6	Zener, 30 V,0.5 W,SOD-123, Optional	Std	Std
1	U1	Primary current sense controller, MSOP8	TI	TPS92310
1	Q1	MOSFET, N-ch, 600 V, 2 A, IPAK	ON/FSC/Infin eon	2N60
1	Q2	PNP transistor, -0.6 A, -60 V, sot23	Std	Std
1	R17	Resistor, chip,1/8w,1%,1.3M,1206	Std	Std
2	R18,R19	Resistor, chip,1/4W,1%,6.8M,1206	Std	Std
1	R20	Resistor, chip,1/8w,1%,100K,0603	Std	Std
1	Q4	N MOSFET, 0.115A, 60 V, SOT23	Std	2N7002L

Table 2. PMP4325 Bill of Materials



3.7 Transformer specification

This section contains transformer specifications for the core and bobbin, the electrical diagram, the electrical specification, and the building construction diagram.

CORE: EPC13

Core material: PC40 or equivalent

Bobbin: 10Pin horizontal bobbin, size is as following:



Figure 35. 10-Pin Horizontal Bobbin



EPC13-10PIN



Figure 36. Transformer Electrical Diagram

Table 3. Transformer Electrical Specification

Electrical Strength	1 second, 60 Hz, from pins 1, 2, 9, 10 to 5, A	3000 V
Primary Inductance	Pins 1-10, all other windings open, measured at 10 kHz, 1V	2.6 MHz+/-10%



Figure 37. Transformer Building Construction Diagram

References

1. TPS92310 Off-Line Primary Side Sensing Controller with PFC datasheet, Texas Instruments

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Security	www.ti.com/security
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Mobile Processors	www.ti.com/omap		
Wireless Connectivity	www.ti.com/wirelessconnectivity		

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2012, Texas Instruments Incorporated